Application Number: 10/656,730 Docket No. P0010524.00 Filed: September 5, 2003 PATENT

## **AMENDMENTS TO THE SPECIFICATION**

Please delete the following paragraph at page 24, line 27 (immediately before the paragraph beginning with "The supporting structures 70"):

For example, U.S. Patent No. 6,478,842 (Gressel et al.) discloses "a process for preparing a molded article comprising . . . admixing a feedstock comprising metal powder and binder; . . . molding the feedstock into an unsintered form; . . . removing the binder, and . . . sintering the unsintered article for a time and at a temperature sufficient to densify the molded article to at least about 95% of the theoretical density of the metal" (column 1, lines 39-48 of Gressel et al.).